

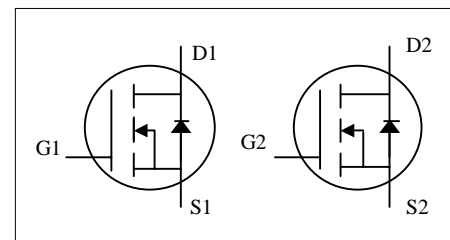
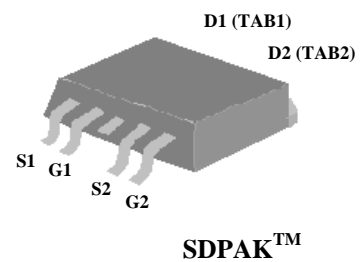
- ▼ Simple Drive Requirement
- ▼ Fast Switching Performance
- ▼ Two Independent Device
- ▼ Halogen Free & RoHS Compliant Product

BV_{DSS}	40V
$R_{DS(ON)}$	13m Ω
I_D	37A

Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, ultra low on-resistance and cost-effectiveness.

SDPAK™ used APEC innovated package and provides two independent device that is suitable and optimum for DC/DC power application.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	40	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D@T_C=25^\circ C$	Continuous Drain Current	37	A
$I_D@T_A=25^\circ C$	Continuous Drain Current ³	11.5	A
$I_D@T_A=70^\circ C$	Continuous Drain Current ³	9.2	A
I_{DM}	Pulsed Drain Current ¹	50	A
$P_D@T_A=25^\circ C$	Total Power Dissipation	3	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Value	Unit
Rthj-c	Maximum Thermal Resistance, Junction-case	4.0	$^\circ C/W$
Rthj-a	Maximum Thermal Resistance, Junction-ambient ³	42	$^\circ C/W$



AP6905GH-HF

Electrical Characteristics @T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	40	-	-	V
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =10A	-	-	13	mΩ
		V _{GS} =4.5V, I _D =7A	-	-	22	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	1	-	3	V
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =10A	-	21	-	S
I _{DSS}	Drain-Source Leakage Current	V _{DS} =40V, V _{GS} =0V	-	-	10	uA
I _{GSS}	Gate-Source Leakage	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Q _g	Total Gate Charge ²	I _D =10A	-	9.5	15	nC
Q _{gs}	Gate-Source Charge	V _{DS} =32V	-	2	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =4.5V	-	6	-	nC
t _{d(on)}	Turn-on Delay Time ²	V _{DS} =20V	-	7	-	ns
t _r	Rise Time	I _D =10A	-	21	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =3.3Ω, V _{GS} =10V	-	18	-	ns
t _f	Fall Time	R _D =2Ω	-	5.5	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	640	1020	pF
C _{oss}	Output Capacitance	V _{DS} =25V	-	140	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	80	-	pF
R _g	Gate Resistance	f=1.0MHz	-	2	3	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{SD}	Forward On Voltage ²	I _S =2.5A, V _{GS} =0V	-	-	1.2	V
t _{rr}	Reverse Recovery Time ²	I _S =10A, V _{GS} =0V,	-	25	-	ns
Q _{rr}	Reverse Recovery Charge	di/dt=100A/μs	-	22	-	nC

Notes:

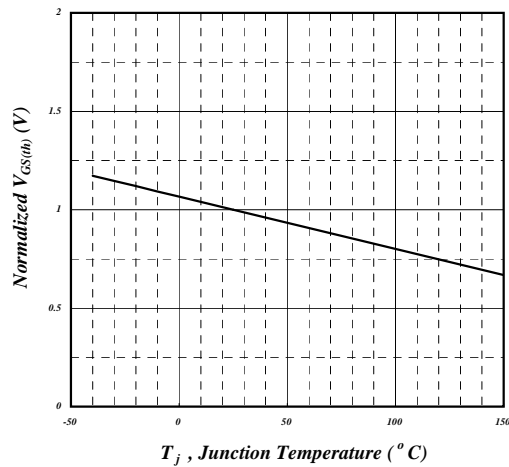
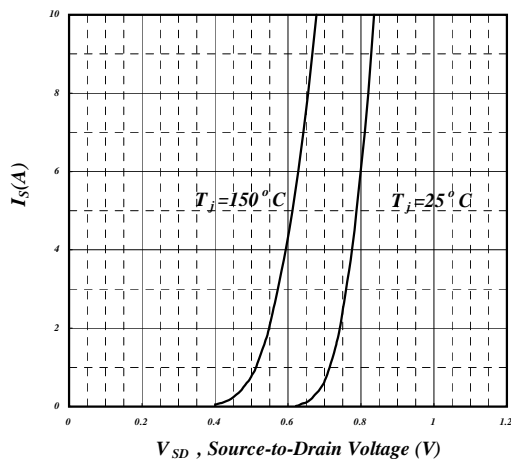
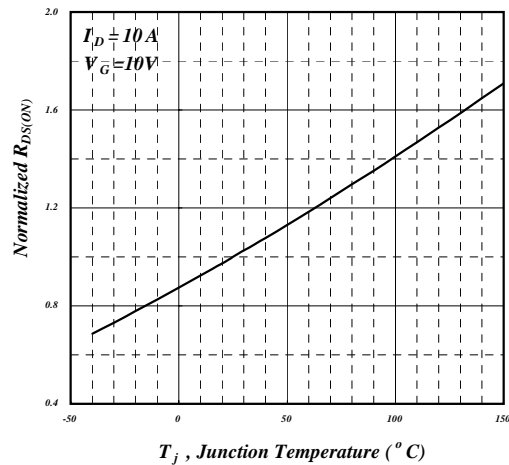
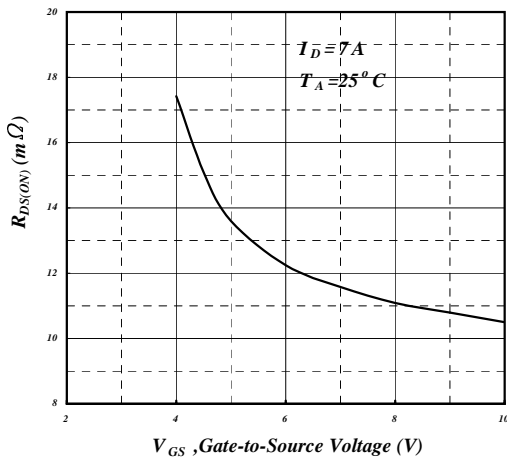
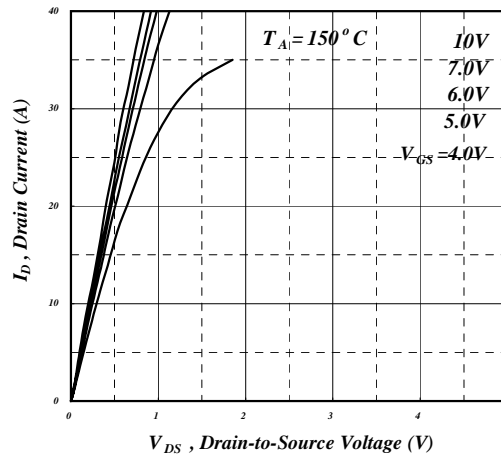
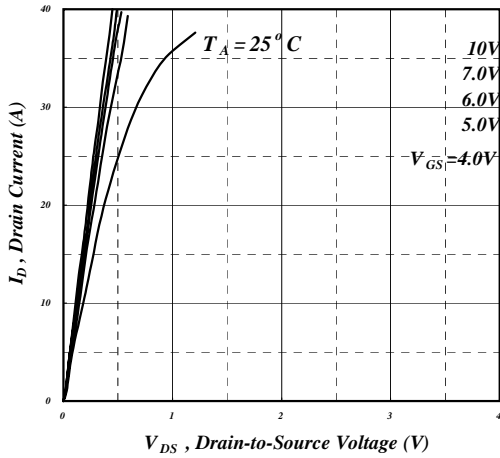
- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.R_{thja} is determined with the device, mounted on 2oz FR4 board t ≤ 10s.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

APEC DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

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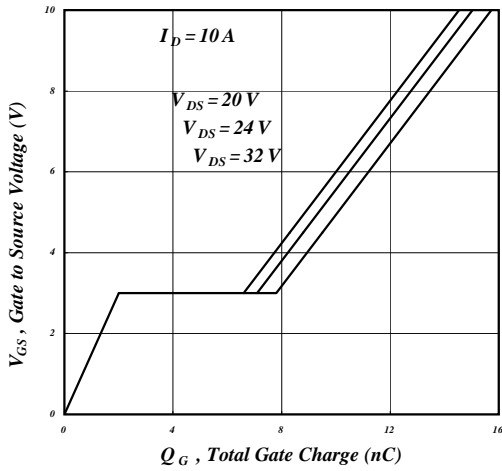


Fig 7. Gate Charge Characteristics

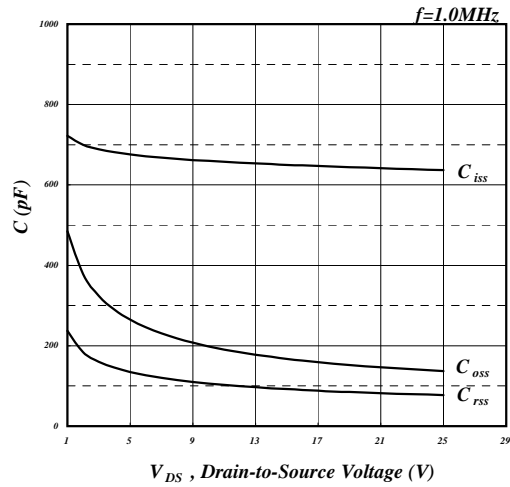


Fig 8. Typical Capacitance Characteristics

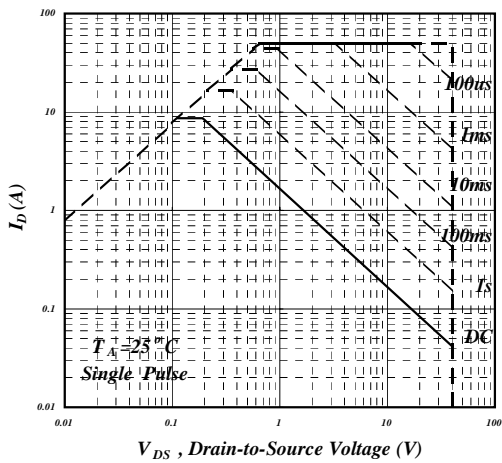


Fig 9. Maximum Safe Operating Area

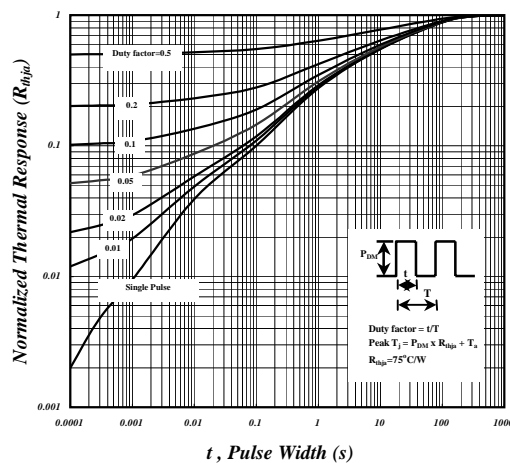


Fig 10. Effective Transient Thermal Impedance

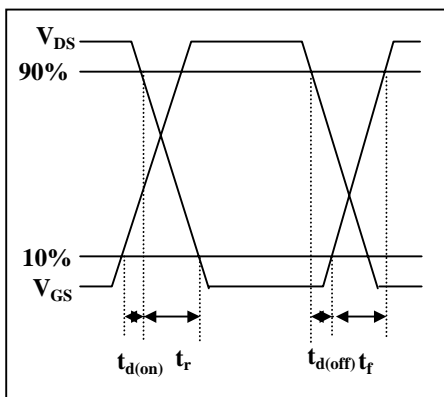


Fig 11. Switching Time Waveform

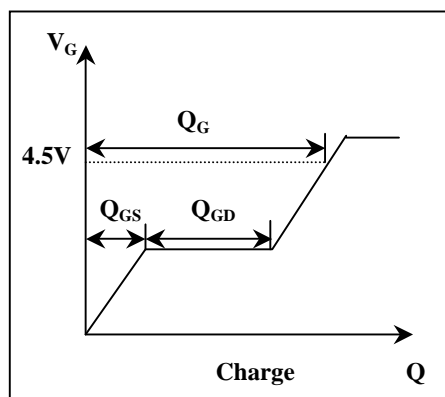


Fig 12. Gate Charge Waveform